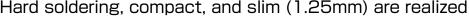
Hard soldering, compact, and slim (1.25mm) are realized







Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	100mΩ max.
Travel (mm)	0.2

■ Product Line

Side push type

Product No.	Operating force	Operating direction	Operating direction Operating life		Minimum order unit (pcs.)		
T TOGGOT TVO.	operating force	Operating direction	(5mA 5V DC)	Guide bosses	Japan	Export	
SKSCLCE010	1.6N		100,000 cycles	Without	5,000	5.000	
SKSCLAE010	2.2N	Side push					
SKSCLDE010	1.6N	Olde pasti	100,000 Cycles	With	5,000	3,000	
SKSCLBE010	2.2N			VVITN			

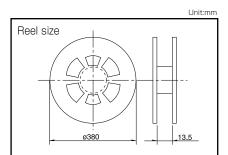
With ground terminal type

Product No.	Operatingforce	Operating direction	ting direction Operating life		Minimum order unit (pcs.)		
	,	, ,	(5mA 5V DC)		Japan	Export	
SKSCPCE010	1.6N		Side push 100,000 cycles -	Without	- 5,000	5,000	
SKSCPAE010	2.2N	Sido puch					
SKSCPDE010	1.6N	Side pasir		With			
SKSCPBE010	2.2N						

■ Packing Specifications

Taping

Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
5,000	50,000	50,000	12	395×395×205

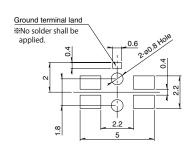


Note

For reels of 330mm diameter, please inquire.

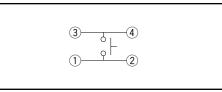
■ Dimensions Unitmm

PC board mounting hole and land dimensions (Viewed from switch mounting face)



Ground terminal land pattern is applicable to ground terminal type only.

Circuit Diagram



Parts indicated by ** apply only to products with a ground terminal.

	T	Sh	narp Feeling Ty	pe		5	Soft Feeling Typ	ne	
	Type		Surface Mount		Snap-in Surface Mount				
	Series	SKSC	SKRT	SKRH	SKPF	SKPS	SKPM	SKPG	SKPR
	Photo								
	Features	Low-profile	_	4-direction switch +push switch	High operation force Long travel	Low contac	t resistance	_	High operation force Low contact resistance
V	Vater-proof	_	_	_	_	_	_	_	_
I	Dust-proof	_	_	_	_	_	_	_	_
I	P standard	_	_	_	_	_	_	_	_
Operatir	Top push	_	_	•	•	•	•	•	•
directio		•	•	•	_	_	_	_	_
	W	3.5	4.5	7.35	8	5	i.9	6.6	7.5
Dimensio	ons D	3.55	3.4	7.5	9	(6	6.3	7.8
(mm)	Н	1.25	3.3	5	10		5		6.5
	Contact	_	_	_	Carbon	Sil	ver	Carbon	Silver
Operation force coverage	2N to 3N	1	\$	See the relevant pages for respective product descriptions		*	1	1	*
Т	ravel (mm)	0.	2	1.75	See the relevant pages for respective product descriptions	1.05	1	.3	1
Gro	ound terminal	0	•	•	_	_	_	_	_
Operat	ting temperature range	−30°C to +85°C	-40℃ to +90℃	-40℃ to +85℃		-	-40°C to +90°	C	
Au	tomotive use	_	_	_	•	•	•	•	•
	Life Cycle	*2	* 2	* 2	* 2	* 2	*3	*3	*3
	Rating (max.) (Resistive load)			mA DC			ImA ' DC	5mA 12V DC	50mA 16V DC
Electrical	Rating (min.) (Resistive load)				10μΑ	1V DC			
performance	Insulation resistance	100MΩ min. 100V DC 1min.							
	Voltage proof	100V AC 1min.	250V AC 1min.	100V AC 1min.			250V AC 1min	1.	
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
Durability	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40°C 96h				-40℃	1,000h	-40℃ 96h	-40℃ 1,000h
Environmental performance	Dry heat	90℃ 96h				90°C 1,000h 90°C 96h		90°C 1,000h	
	Damp heat		60°C, 90 to	95%RH 96h		60°C, 90 to 9	5%RH 1,000h	60°C, 90 to 95%RH 96h	60°C, 90 to 95%RH 1,000h
	Page	239	241	444	244	245	246	247	248

Notes

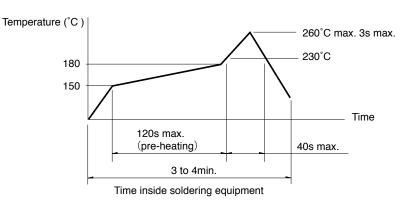
- 1. The automotive operating temperature range to be individually discussed upon request.
- 2. Indicates applicability to all products in the series.

D: Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

TACT Switch™ / Soldering Conditions

Condition for Reflow Available for Surface Mount Type. Temperature profile



Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

■ Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA CORPORATION, or equivalents.)

